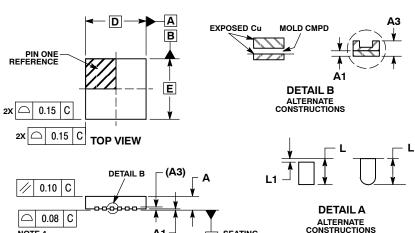


NOTE 4

QFN24, 4x4, 0.5P CASE 485CW **ISSUE 0**

DATE 15 NOV 2012



C SEATING PLANE

- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: MILLIMETERS.
- COPHNOLLING DIMENSION. MILLIME FAN.
 DIMENSION & APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30 MM FROM THE TERMINAL TIP.
 COPLANARITY APPLIES TO THE EXPOSED PAD
- AS WELL AS THE TERMINALS.

	MILLIMETERS		
DIM	MIN	MAX	
Α	0.80	1.00	
A1	0.00	0.05	
A3	0.20 REF		
b	0.21	0.31	
D	4.00 BSC		
D2	2.10	2.30	
Е	4.00 BSC		
E2	2.10	2.30	
е	0.50 BSC		
L	0.30	0.50	
11		0.15	

GENERIC MARKING DIAGRAM*



XXXXXX= Specific Device Code

= Assembly Location Α

L = Wafer Lot = Year = Work Week W

= Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

المعاملات ondlann' 0.10 C A B е Ф e/2 0.05 C NOTE 3 **BOTTOM VIEW**

Α1

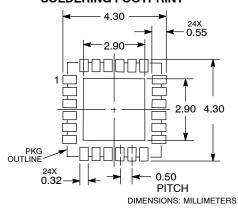
- 24X L

SIDE VIEW

<- D2→

DETAIL A

RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION:	QFN24, 4X4, 0.5P	PAGE 1 OF 2	



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